

PRODUCT NUMBER

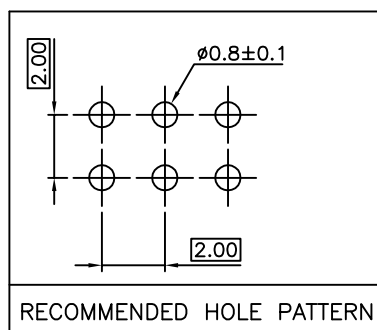
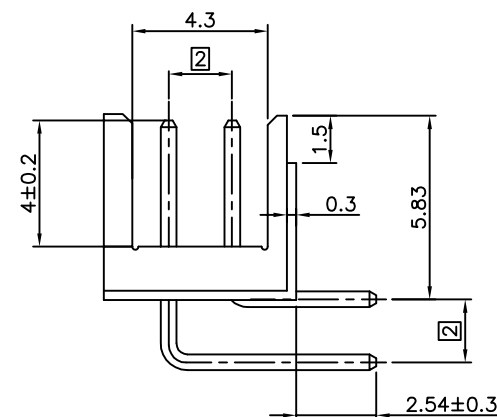
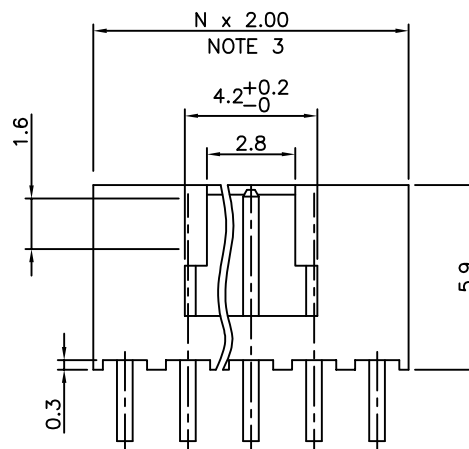
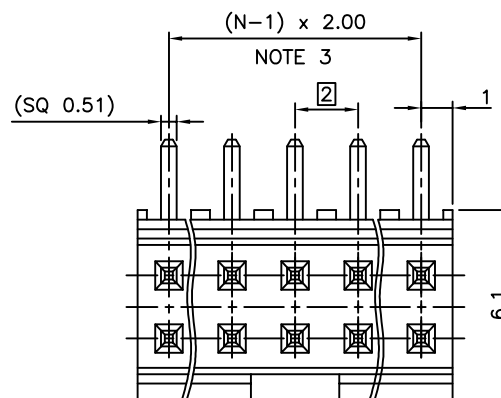
95609-XXXLF

PLATING

- 0 = 0.20µm Au/GXT
- 1 = 0.76µm Au/GXT
- 3 = 0.38µm Au/GXT
- 5 = 0.38µm GXT
- 6 = 0.76µm GXT

1.27µm Ni MIN UNDERPLATING

RoHS COMPATIBLE, SEE NOTE 6
TOTAL NB OF POSITIONS, 08 TO 34



RECOMMENDED HOLE PATTERN

NOTES:

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR CREAM
2. MATERIAL TERMINAL: COPPER ALLOY
3. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW
4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
5. STANDARD PACKAGING IN POLYBAGS.
6. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
 - a - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
 - b - LABELLING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - c - THIS PRODUCT MEETS EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBED IN GS-47-0004

mat'l. code				surface	tolerance	projection	product family		
SEE NOTES				ISO 1302	ISO 406 ISO 101		MINITEK HEADER		
ltr	ecn no	dr	date	tolerances unless otherwise specified	linear	mm	title		
C	F05-0128	LMU	05.02.21	angles	.X	±0.3	SHR HEADER 2.00mm TMT R/A		
D	F06-0210	LMU	06.07.04	linear	.XX	±0.13			
E	F08-0145	ELA	15.04.08	±2'	.XXX	±0.05	scale 7:1		
F	B-19190	LMU	14.10.24	dr	L.MULIN	02.06.19	FCI		
G	F-21746	AMA	15.08.21	engr	J.COMPAGNON	02.06.19			
				chr			dwg no		
				appo	JMC	02.06.19	sheet 1 of 1		
							95609		
							A3		
							type		
							CUSTOMER Drawing		
sheet index	revision	sheet							